74HC4020; 74HCT4020

14-stage binary ripple counter

Rev. 7 — 18 June 2020

Product data sheet

1. General description

The 74HC4020; 74HCT4020 is a 14-stage binary ripple counter with a clock input (\overline{CP}) , an overriding asynchronous master reset input (MR) and 12 buffered parallel outputs (Q0, and Q3 to Q13). The counter advances on the HIGH-to-LOW transition of \overline{CP} . A HIGH on MR clears all counter stages and forces all outputs LOW, independent of the state of \overline{CP} . Each counter stage is a static toggle flip-flop. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- · High noise immunity
- · Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- Input levels:
 - For 74HC4020: CMOS level
 - For 74HCT4020: TTL level
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

- Frequency dividing circuits
- · Time delay circuits
- Control counters

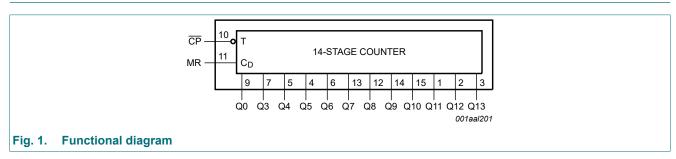


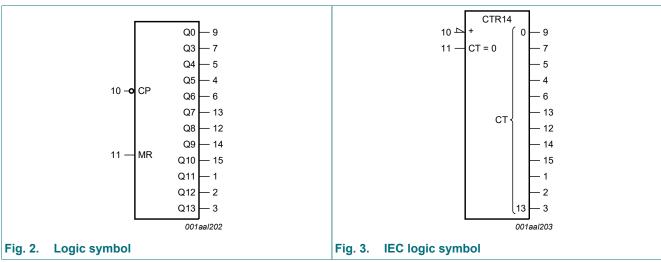
4. Ordering information

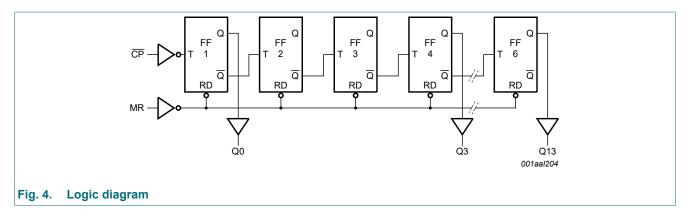
Table 1. Ordering information

Type number	Package	Package								
	Temperature range	Name	Description	Version						
74HC4020D	-40 °C to +125 °C	SO16 plastic small outline package; 16 leads;		SOT109-1						
74HCT4020D			body width 3.9 mm							
74HC4020DB	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1						
74HC4020PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1						
74HCT4020PW			body width 4.4 mm							
74HC4020BQ	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced	SOT763-1						
74HCT4020BQ			very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm							

5. Functional diagram

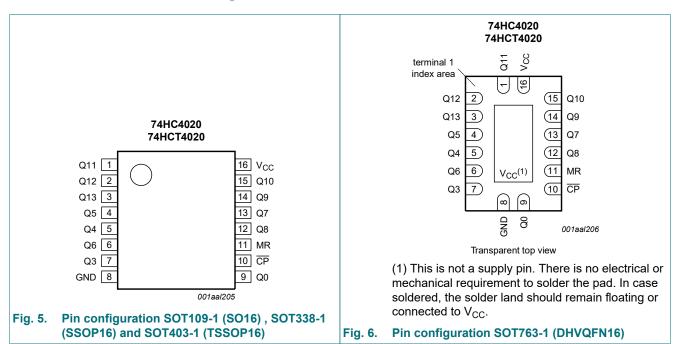






6. Pinning information

6.1. Pinning



6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description			
Q0, Q3 to Q13	9, 7, 5, 4, 6, 13, 12, 14, 15, 1, 2, 3	output			
GND	8	ground (0 V)			
CP	10	clock input (HIGH-to-LOW, edge-triggered)			
MR	11	master reset input (active HIGH)			
Vcc	16	positive supply voltage			

7. Functional description

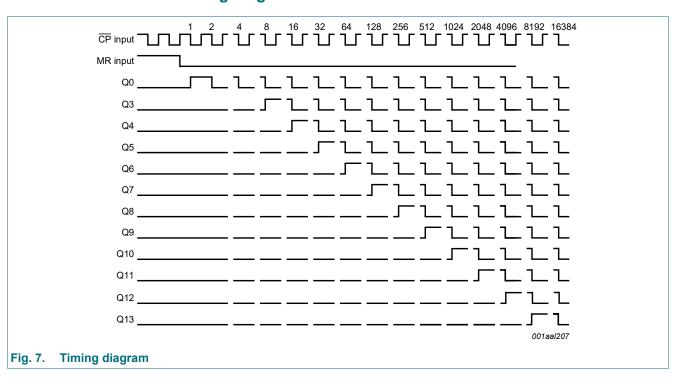
Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care;

 \uparrow = LOW-to-HIGH clock transition; \downarrow = HIGH-to-LOW clock transition.

Input	Output	
P MR		Q0, Q3 to Q13
1	L	no change
\downarrow	L	count
X	Н	L

7.1. Timing diagram



8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{OK}	output clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _O	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	±50	mA
I _{GND}	ground current			-	±50	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[1]	-	500	mW

^[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT338-1 (SSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P_{tot} derates linearly with 11.2 mW/K above 106 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	7	4HC402	:0	74HCT4020			Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	Vcc	0	-	V _{CC}	V
Δt/ΔV	input transition rise	except for Schmitt trigger inputs							
	and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC402	20			'			1		<u>'</u>	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH} HIGH-level	V _I = V _{IH} or V _{IL}									
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT4	020									
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL} LOW-level	-	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
ΔI _{CC}	additional supply current	$V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		pin MR	-	110	396	-	495	-	539	μΑ
		pin CP	-	85	306	-	383	-	417	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 10

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC40	20									
t _{pd}	propagation	<u>CP</u> to Q0; see <u>Fig. 8</u> [1]								
	delay	V _{CC} = 2.0 V	-	39	140	-	175	-	210	ns
		V _{CC} = 4.5 V	-	14	28	-	35	-	42	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	11	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	11	24	-	30	-	36	ns
		Qn to Qn+1; see Fig. 9								
		V _{CC} = 2.0 V	-	22	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	8	15	-	19	-	22	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	6	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _{PHL}	HIGH to LOW	MR to Qn; see Fig. 8								
	propagation delay	V _{CC} = 2.0 V	-	55	170	-	215	-	225	ns
	delay	V _{CC} = 4.5 V	-	20	34	-	43	-	51	ns
		V_{CC} = 5.0 V; C_L = 15 pF	-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	16	29	-	37	-	43	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _t	transition time	Qn; see Fig. 8 [2]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _W	pulse width	CP HIGH or LOW; see Fig. 8								
		V _{CC} = 2.0 V	80	14	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	4	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	3	-	17	-	20	-	ns
		MR HIGH; see Fig. 8								
		V _{CC} = 2.0 V	80	17	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	6	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	5	-	17	-	20	-	ns
t _{rec}	recovery time	MR to CP; see Fig. 8								
		V _{CC} = 2.0 V	50	6	-	65	-	75	-	ns
		V _{CC} = 4.5 V	10	2	-	13	-	15	-	ns
		V _{CC} = 6.0 V	9	2	-	11	-	13	-	ns
f _{max}	maximum	see Fig. 8								
	frequency	V _{CC} = 2.0 V	6.0	30	-	4.8	-	4.0	-	MHz
		V _{CC} = 4.5 V	30	92	-	24	-	20	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	101	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	35	109	-	28	-	24	-	MHz
C _{PD}	power dissipation capacitance	[3]	-	19	-	-	-	-	-	pF
74HCT4	020									<u> </u>
t _{pd}	propagation	CP to Q0; see <u>Fig. 8</u> [1]								
F	delay	V _{CC} = 4.5 V	-	18	36	-	45	-	54	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
		Qn to Qn+1; see Fig. 9								
		V _{CC} = 4.5 V	-	8	15	-	19	-	22	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	6	-	-	-	-	-	ns
t _{PHL}	HIGH to LOW	MR to Qn; see Fig. 8								
	propagation	V _{CC} = 4.5 V	-	22	45	-	56	-	68	ns
	delay	V _{CC} = 5.0 V; C _L = 15 pF	-	19	-	-	-	-	-	ns
t _t	transition time	Qn; see Fig. 8 [2]								
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
t _W	pulse width	CP HIGH or LOW; see Fig. 8								
		V _{CC} = 4.5 V	20	7	-	25	-	30	-	ns
		MR HIGH; see Fig. 8								
		V _{CC} = 4.5 V	20	8	-	25	-	30	-	ns
t _{rec}	recovery time	MR to CP; see Fig. 8								
		V _{CC} = 4.5 V	10	2	-	13	-	15	-	ns

Symbol	ymbol Parameter Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit		
				Min	Тур	Max	Min	Max	Min	Max	
IIIdx	maximum	see Fig. 8									
	frequency	V _{CC} = 4.5 V		25	47	-	20	-	17	-	MHz
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	52	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance		[3]	-	20	-	-	-	-	-	pF

- t_{pd} is the same as t_{PHL} and $t_{\text{PLH}}.$ [1]
- t_t is the same as t_{THL} and t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

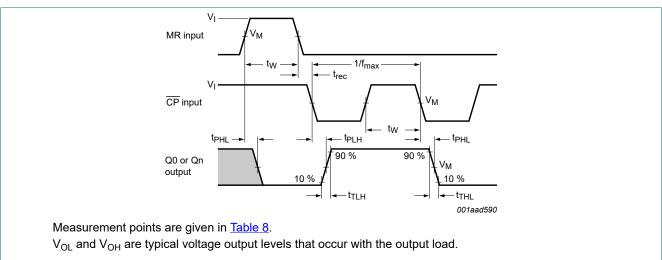
f_o = output frequency in MHz;

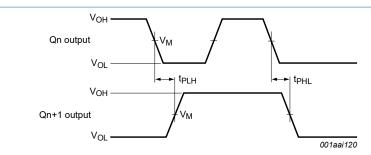
 $\Sigma (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs};$

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V.

11.1. Waveforms and test circuit





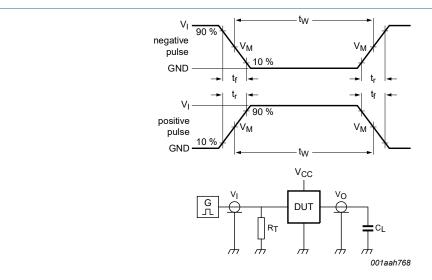
Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 9. Waveforms showing the output Qn to output Qn+1 propagation delays

Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC4020	0.5 x V _{CC}	0.5 x V _{CC}
74HCT4020	1.3 V	1.3 V



Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = Load capacitance including jig and probe capacitance.

Fig. 10. Test circuit for measuring switching times

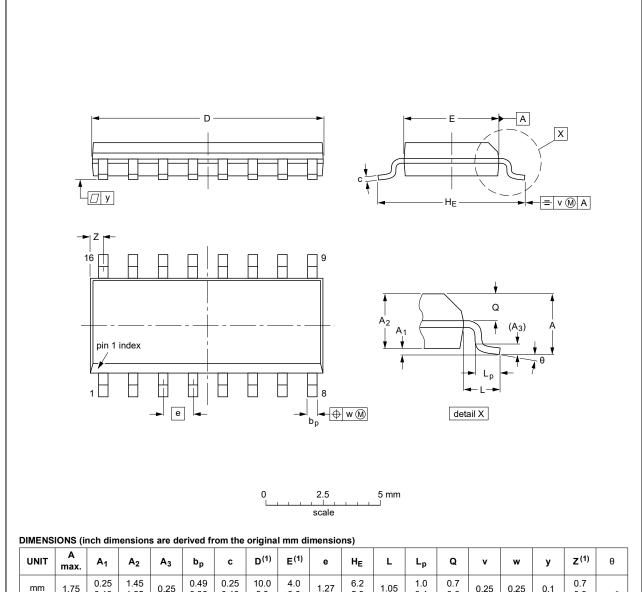
Table 9. Test data

Туре	Input	Load	
	V _I	t _r , t _f	C _L
74HC4020	V _{CC}	6 ns	15 pF, 50 pF
74HCT4020	3 V	6 ns	15 pF, 50 pF

12. Package outline



SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

Fig. 11. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

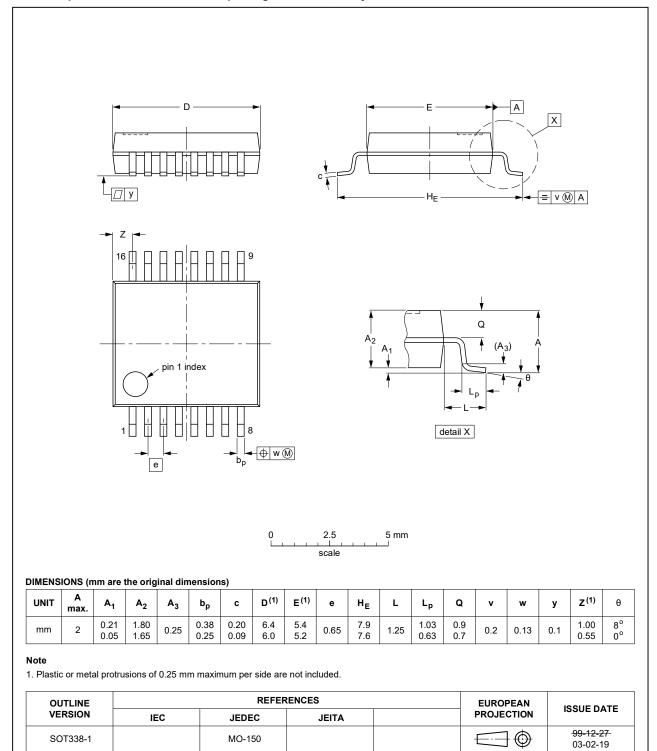
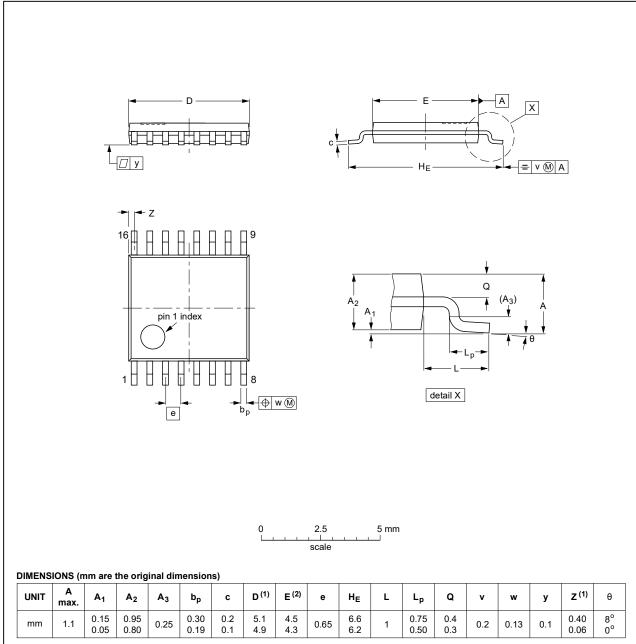


Fig. 12. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				99-12-27 03-02-18	

Fig. 13. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

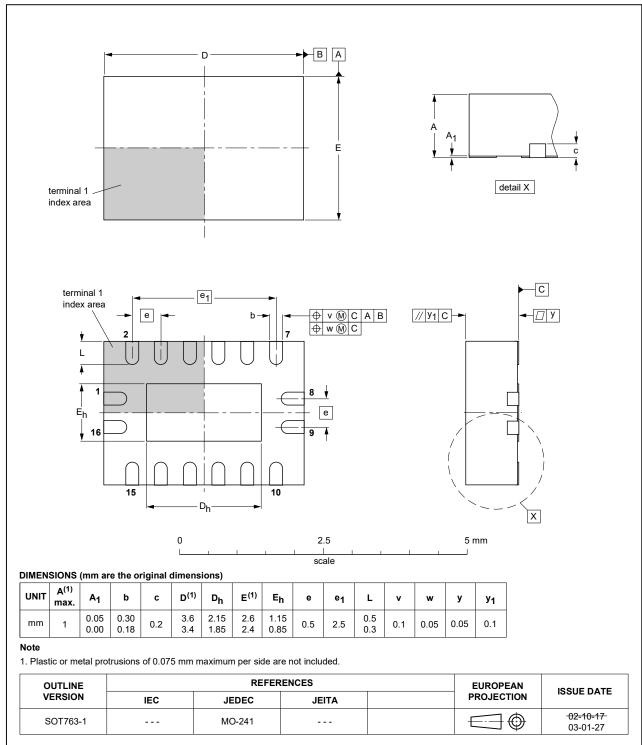


Fig. 14. Package outline SOT763-1 (DHVQFN16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT4020 v.7	20200618	Product data sheet	-	74HC_HCT4020 v.6			
Modifications:	Nexperia. Legal texts have bee Type number 74HCl Section 1 and Section	Legal texts have been adapted to the new company name where appropriate. Type number 74HCT4020DB (SOT338-1/SSOP16) removed. Section 1 and Section 2 updated.					
74HC_HCT4020 v.6	20160203	Product data sheet	-	74HC_HCT4020 v.5			
Modifications:	Type numbers 74HC	4020N and 74HCT4020N	N (SOT38-4) remov	/ed.			
74HC_HCT4020 v.5	20120806	Product data sheet	-	74HC_HCT4020 v.4			
Modifications:	Measurement points	added to Fig. 8 (errata).					
74HC_HCT4020 v.4	20111213	Product data sheet	-	74HC_HCT4020 v.3			
Modifications:	Legal pages updated.						
74HC_HCT4020 v.3	20100120	Product data sheet	-	74HC_HCT4020 v.2			
74HC_HCT4020 v.2	19970901	Product specification	-	-			

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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